

Dual 12-Bit Rail-to-Rail Micropower DACs

August 1996

FEATURES

- 12-Bit Resolution
- **Buffered True Rail-to-Rail Voltage Output**
- 5V Operation, I_{CC} : 700 μ A Typ (LTC1454)
- 3V Operation, I_{CC} : 450 μ A Typ (LTC1454L)
- Built-In Reference: 2.048V (LTC1454)
1.220V (LTC1454L)
- $\overline{\text{CLR}}$ Pin
- Power-On Reset
- **16-Lead SO Package**
- 3-Wire Cascadable Serial Interface
- **Maximum DNL Error: 0.5LSB**
- Low Cost

APPLICATIONS

- Digital Calibration
- Industrial Process Control
- Automatic Test Equipment
- Cellular Telephones

DESCRIPTION

The LTC[®]1454/LTC1454L are complete single supply, dual rail-to-rail voltage output, 12-bit digital-to-analog converters (DACs) in an 16-lead SO package. They include an output buffer amplifier with variable gain ($\times 1$ or $\times 2$) and an easy-to-use 3-wire cascadable serial interface.

The LTC1454 has an onboard reference of 2.048V and a full-scale output of 4.095V in a $\times 2$ gain configuration. It operates from a single 4.5V to 5.5V supply.

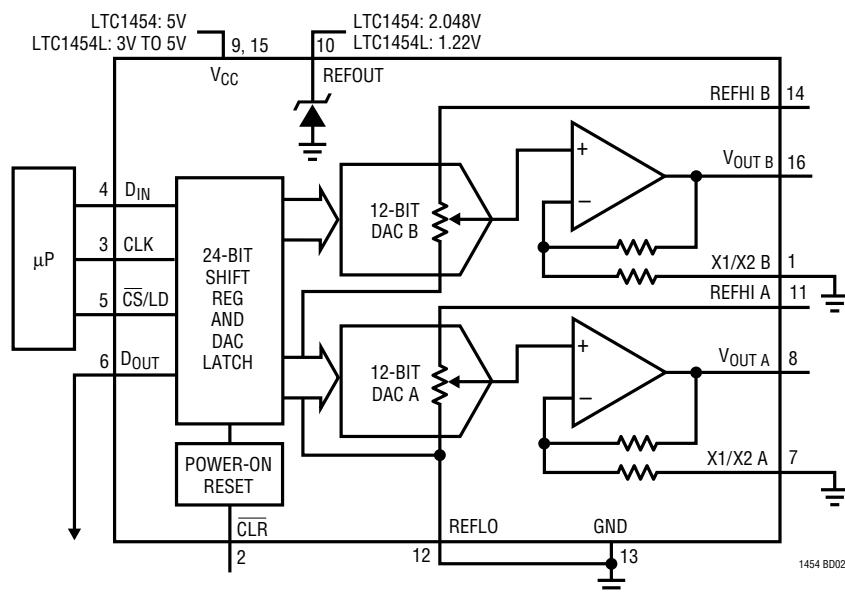
The LTC1454L has an onboard 1.22V reference and a full-scale output of 2.5V in a $\times 2$ gain configuration. It operates from a single supply of 2.7V to 5.5V.

Low power supply current, excellent DNL and small size allows these parts to be used in a host of applications where size, DNL and single supply operation are important.

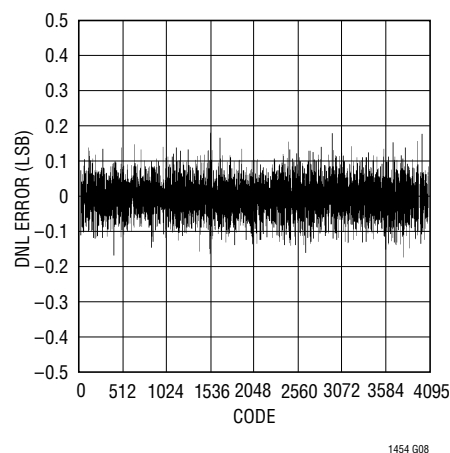
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TYPICAL APPLICATION

Functional Block Diagram: Dual 12-Bit Rail-to-Rail DAC



Differential Nonlinearity vs Input Code



ABSOLUTE MAXIMUM RATINGS

V_{CC} to GND	–0.5V to 7.5V
TTL Input Voltage	–0.5V to 7.5V
$V_{OUT A}$, $V_{OUT B}$, X1/X2 A, X1/X2 B	–0.5V to $V_{CC} + 0.5V$
REFHI A, REFHI B, REFLO	–0.5V to $V_{CC} + 0.5V$
Maximum Junction Temperature	–65°C to 125°C
Operating Temperature Range	
Commercial	0°C to 70°C
Industrial	–40°C to 85°C
Storage Temperature Range	–65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

TOP VIEW			ORDER PART NUMBER
X1/X2 B	1	16	$V_{OUT\ B}$
CLR	2	15	V_{CC}
CLK	3	14	REFHI B
D_{IN}	4	13	GND
\overline{CS}/LD	5	12	REFLO
D_{OUT}	6	11	REFHI A
X1/X2 A	7	10	REFOUT
$V_{OUT\ A}$	8	9	V_{CC}
N PACKAGE 16-LEAD PDIP		LTC1454CN LTC1454IN LTC1454CS LTC1454IS LTC1454LCN LTC1454LIN LTC1454LCS LTC1454LIS	
S PACKAGE 16-LEAD PLASTIC SO			
$T_{JMAX} = 125^{\circ}C$, $\theta_{JA} = 100^{\circ}C/W$ (N)			
$T_{JMAX} = 125^{\circ}C$, $\theta_{JA} = 150^{\circ}C/W$ (S)			

Consult factory for Military grade parts.

ELECTRICAL CHARACTERISTICS

$V_{CC} = 4.5V$ to $5.5V$ (LTC1454), $2.7V$ to $5.5V$ (LTC1454L), X1/X2 = REFLO = GND, REFHI = REFOUT, V_{OUT} and REFOUT unloaded, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
DAC							
	Resolution		●	12			Bits
DNL	Differential Nonlinearity	Guaranteed Monotonic (Note 1)	●	±0.5			LSB
INL	Integral Nonlinearity	T _A = 25°C (Note 1)	●		±2.0	±4.0	LSB
					±2.5	±4.5	LSB
V _{OS}	Offset Error	T _A = 25°C	●		±2.0	±12	mV
					±4.0	±18	mV
V _{OS} TC	Offset Error Temperature Coefficient			±15			µV/°C
V _{FS}	Full-Scale Voltage	When Using Internal Reference, LTC1454, T _A = 25°C LTC1454	●	4.065	4.095	4.125	V
				4.045	4.095	4.145	V
		When Using Internal Reference, LTC1454L, T _A = 25°C LTC1454L	●	2.470	2.500	2.530	V
				2.460	2.500	2.540	V
V _{FS} TC	Full-Scale Voltage	When Using Internal Reference, LTC1454 LTC1454L			±24	±24	ppm/°C ppm/°C
Reference							
	Reference Output Voltage	LTC1454 LTC1454L	●	2.008 1.195	2.048 1.220	2.088 1.245	V V
	Reference Output Temperature Coefficient			±20			ppm/°C
	Reference Line Regulation		●		0.7	±2.0	LSB/V
	Reference Load Regulation	0 ≤ I _{OUT} ≤ 100µA, LTC1454 LTC1454L	● ●		0.2 0.6	1.5 3.0	LSB LSB
	Reference Input Range	V _{REFHI} ≤ V _{CC} – 1.5V		V _{CC} /2			V
	Reference Input Resistance		●	15	24	40	kΩ
	Reference Input Capacitance			15			pF
	Short-Circuit Current	REFOUT Shorted to GND	●		40	120	mA

ELECTRICAL CHARACTERISTICS

$V_{CC} = 4.5V$ to $5.5V$ (LTC1454), $2.7V$ to $5.5V$ (LTC1454L), $X1/X2 = REFLO = GND$, $REFHI = REFOUT$, V_{OUT} and $REFOUT$ unloaded, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Power Supply							
V_{CC}	Positive Supply Voltage	For Specified Performance, LTC1454 LTC1454L	●	4.5		5.5	V
			●	2.7		5.5	V
I_{CC}	Supply Current	$4.5V \leq V_{CC} \leq 5.5V$ (Note 4), LTC1454 $2.7V \leq V_{CC} \leq 5.5V$ (Note 4), LTC1454L	●		700	1250	μA
			●		450	1100	μA

Op Amp DC Performance

	Short-Circuit Current Low	V_{OUT} Shorted to GND	●		70	120	mA
	Short-Circuit Current High	V_{OUT} Shorted to V_{CC}	●		80	120	mA
	Output Impedance to GND	Input Code = 0	●		40		Ω

AC Performance

	Voltage Output Slew Rate	(Note 2)	●	0.5	1.0		V/ μs
	Voltage Output Settling Time	(Notes 2, 3) to $\pm 0.5LSB$			14		μs
	Digital Feedthrough				0.3		nV $\cdot s$
	AC Feedthrough	REFHI = 1kHz, 2V _{P-P} , (Code: All 0s)			-95		dB
SINAD	Signal-to-Noise + Distortion	REFHI = 1kHz, 2V _{P-P} , (Code: All 1s)			85		dB

$V_{CC} = 5V$ (LTC1454), $3V$ (LTC1454L), $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		LTC1454			LTC1454L			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
Digital I/O										
V _{IH}	Digital Input High Voltage		●	2.4			2.0			V
V _{IL}	Digital Input Low Voltage		●			0.8			0.6	V
V _{OH}	Digital Output High Voltage	I _{OUT} = −1mA	●	V _{CC} − 1.0			V _{CC} − 0.7			V
V _{OL}	Digital Output Low Voltage	I _{OUT} = 1mA	●			0.4			0.4	V
I _{LEAK}	Digital Input Leakage	V _{IN} = GND to V _{CC}	●			±10			±10	μA
C _{IN}	Digital Input Capacitance	Guaranteed by Design. Not Subject to Test	●			10			10	pF

Switching

t_1	D_{IN} Valid to CLK Setup		●	40			60			ns
t_2	D_{IN} Valid to CLK Hold		●	0			0			ns
t_3	CLK High Time		●	40			60			ns
t_4	CLK Low Time		●	40			60			ns
t_5	\overline{CS}/LD Pulse Width		●	50			80			ns
t_6	LSB CLK to \overline{CS}/LD		●	40			60			ns
t_7	\overline{CS}/LD Low to CLK		●	20			30			ns
t_8	D_{OUT} Output Delay	$C_{LOAD} = 15pF$	●			150			220	ns
t_9	CLK Low to \overline{CS}/LD Low		●	20			30			ns

The ● denotes specifications which apply over the full operating temperature range.

Note 1: Nonlinearity is defined from the first code that is greater than or equal to the maximum offset specification to code 4095 (full scale).

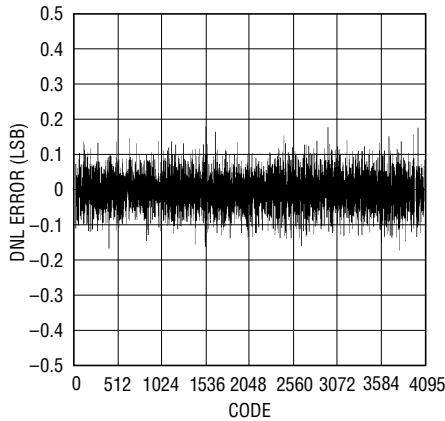
Note 2: Load is 5k Ω in parallel with 100pF.

Note 3: DAC switched between all 1s and the code corresponding to V_{OS} for the part.

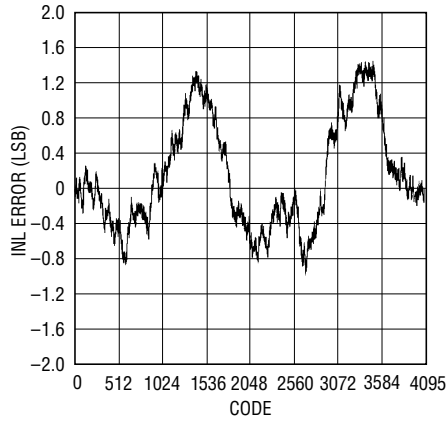
Note 4: Digital inputs at 0V or V_{CC} .

TYPICAL PERFORMANCE CHARACTERISTICS

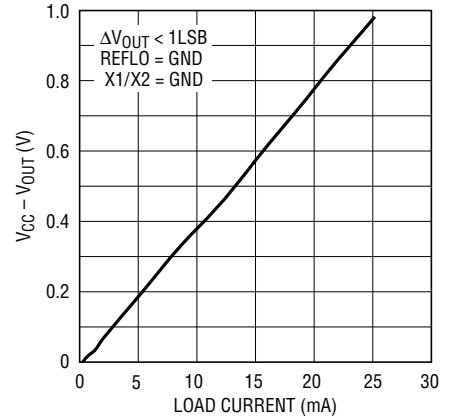
LTC1454
Differential Nonlinearity



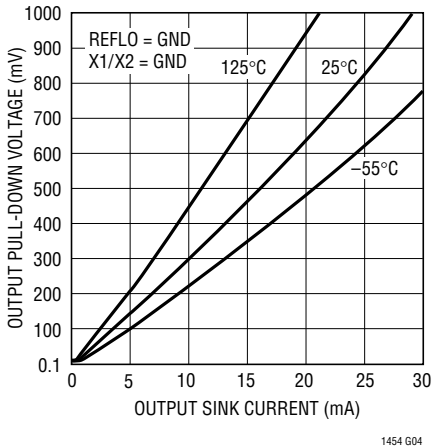
LTC1454
Integral Nonlinearity



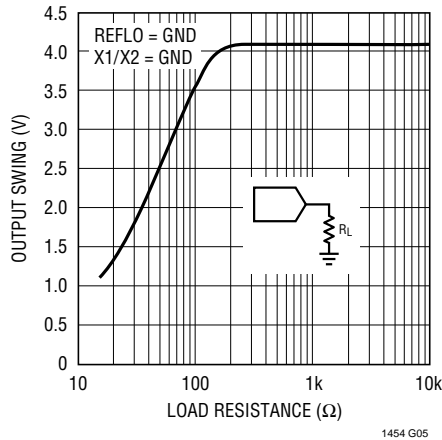
Minimum Supply Headroom for Full Output Swing vs Load Current



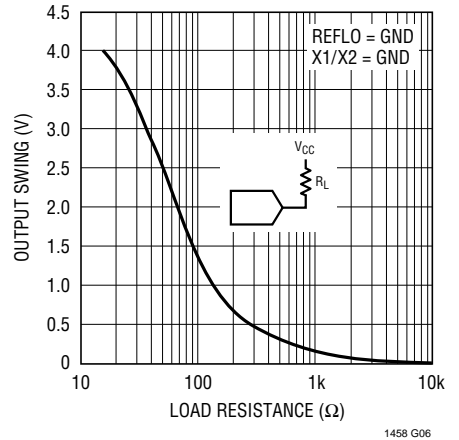
LTC1454 Minimum Output Voltage vs Output Sink Current



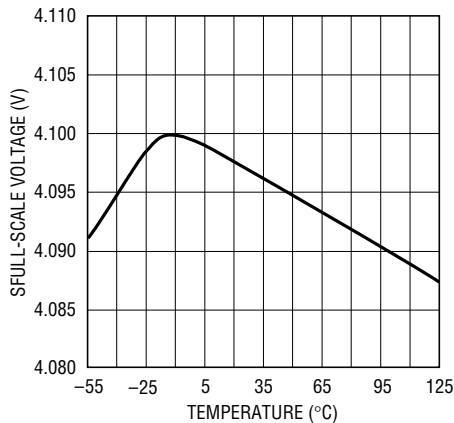
LTC1454 Output Swing vs Load Resistance



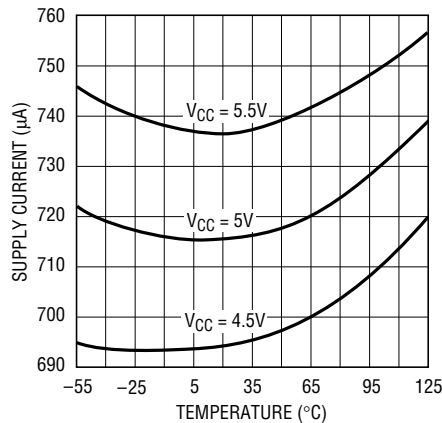
LTC1454 Output Swing vs Load Resistance



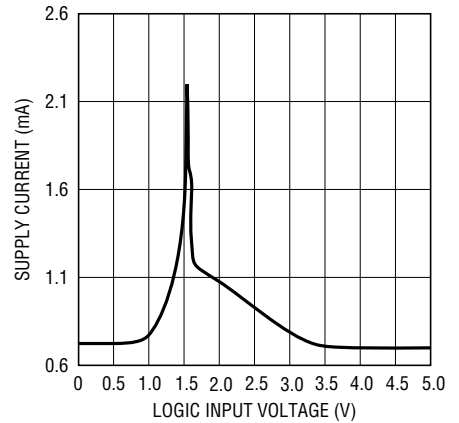
LTC1454 Full-Scale Voltage vs Temperature



LTC1454
Supply Current vs Temperature



LTC1454 Supply Current vs Logic Input Voltage



PIN FUNCTIONS

X1/X2 B, X1/X2 A (Pins 1, 7): The Input Pin that Sets the Gain for DAC A/B. When grounded the gain will be 2, i.e., output full scale will be $\times 2$ REFHI. When connected to V_{OUT} the gain will be 1, i.e., output full scale will be equal to REFHI.

CLR (Pin 2): The Clear Pin for the DAC. Clears both DACs to zero scale when pulled low. This pin should be tied to V_{CC} for normal operation.

CLK (Pin 3): The Serial Interface Clock Input.

D_{IN} (Pin 4): The Serial Data Input. Data on the D_{IN} pin is latched into the shift register on the rising edge of the serial clock. Data is loaded as one 24-bit word. The first 12 bits are for DAC A, MSB-first and the second 12 bits are for DAC B, MSB-first.

\overline{CS}/LD (Pin 5): The Serial Interface Enable and Load Control Input. When \overline{CS}/LD is low the CLK signal is enabled so the data can be clocked in. When \overline{CS}/LD is

pulled high, data is loaded from the shift register into the DAC register, updating the DAC output.

D_{OUT} (Pin 6): The Output of the Shift Register which Becomes Valid on the Rising Edge of the Serial Clock.

V_{OUT A}, V_{OUT B} (Pins 8, 16): The Buffered DAC Outputs.

V_{CC} (Pins 9, 15): The Positive Supply Input. $4.5 \leq V_{CC} \leq 5.5V$ (LTC1454), $2.7V \leq V_{CC} \leq 5.5V$ (LTC1454L). Requires a bypass capacitor to ground.

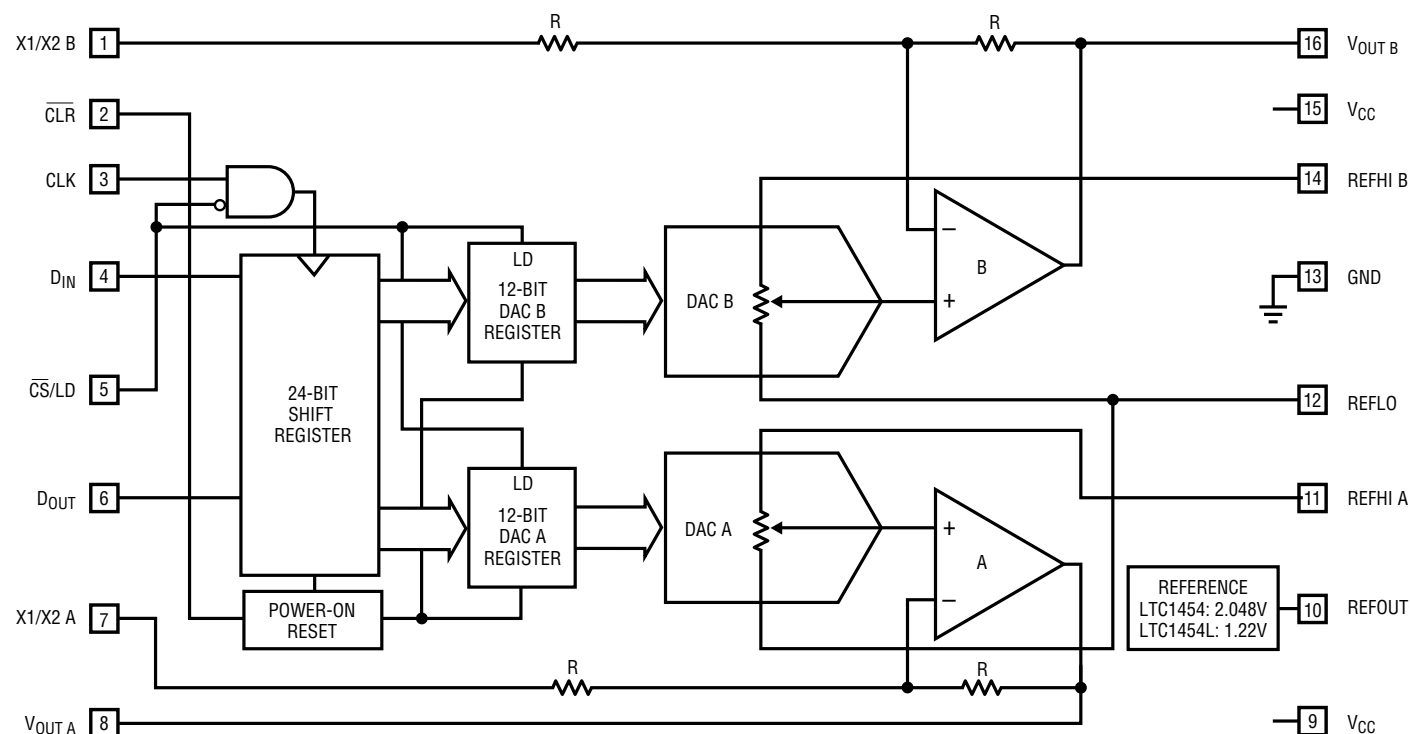
REFOUT (Pin 10): The Output of the Internal Reference.

REFHI A, REFHI B (Pins 11, 14): The Inputs to the DAC Resistor Ladder for DAC A/B.

REFLO (Pin 12): The Bottom of the DAC Resistor Ladder for Both DACs. This can be used to offset zero-scale above ground. REFLO should be connected to ground when no offset is required.

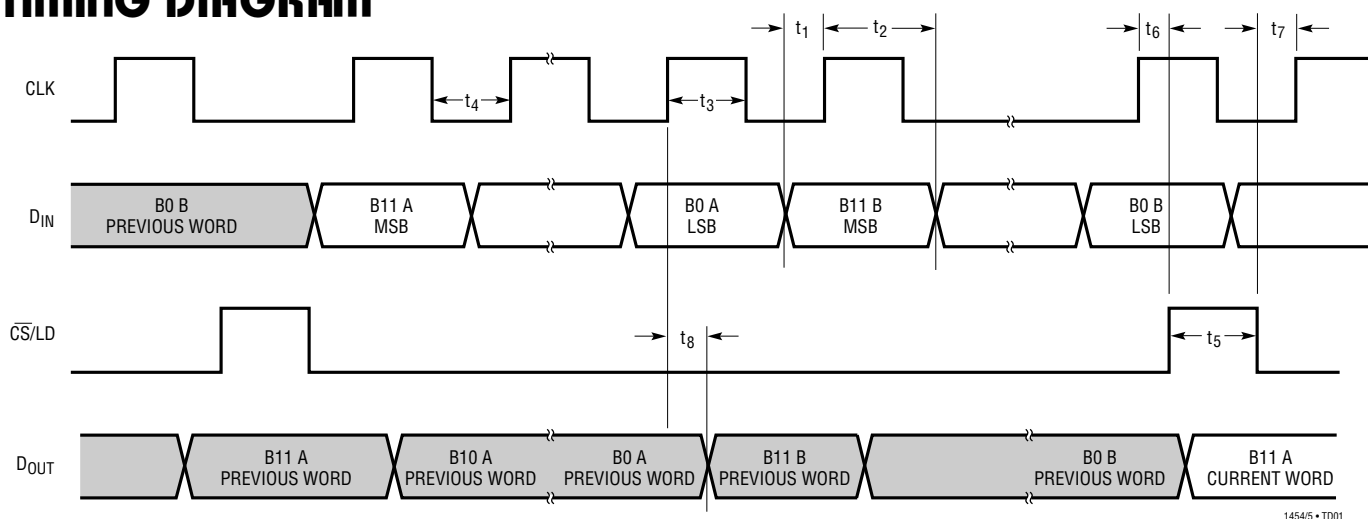
GND (Pin 13): Ground.

BLOCK DIAGRAM



1454 BD01

TIMING DIAGRAM



DEFINITIONS

Resolution (n): Resolution is defined as the number of digital input bits, n. It defines the number of DAC output states (2^n) that divide the full-scale range. The resolution does not imply linearity.

Full-Scale Voltage (V_{FS}): This is the output of the DAC when all bits are set to 1.

Voltage Offset Error (V_{OS}): The theoretical voltage at the output when the DAC is loaded with all zeros. The output amplifier can have a true negative offset, but because the part is operated from a single supply, the output cannot go below zero. If the offset is negative, the output will remain near 0V resulting in the transfer curve shown in Figure 1.

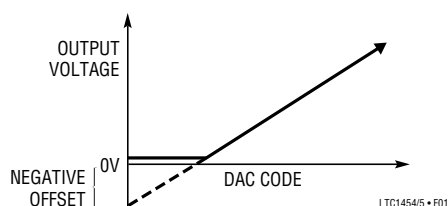


Figure 1. Effect of Negative Offset

The offset of the part is measured at the code that corresponds to the maximum offset specification:

$$V_{OS} = V_{OUT} - (\text{Code})(V_{FS})/(2^n - 1)$$

Least Significant Bit (LSB): One LSB is the ideal voltage difference between two successive codes.

$$\text{LSB} = (V_{FS} - V_{OS})/(2^n - 1) = (V_{FS} - V_{OS})/4095$$

Nominal LSBs:

$$\text{LTC1454} \quad \text{LSB} = 4.095\text{V}/4095 = 1\text{mV}$$

$$\text{LTC1454L} \quad \text{LSB} = 2.5\text{V}/4095 = 0.610\text{mV}$$

Integral Nonlinearity (INL): End-point INL is the maximum deviation from a straight line passing through the end-points of the DAC transfer curve. Because the part operates from a single supply and the output cannot go below zero, the linearity is measured between full scale and the code corresponding to the maximum offset specification. The INL error at a given input code is calculated as follows:

$$\text{INL} = [V_{OUT} - V_{OS} - (V_{FS} - V_{OS})(\text{Code}/4095)]/\text{LSB}$$

V_{OUT} = The output voltage of the DAC measured at the given input code

Differential Nonlinearity (DNL): DNL is the difference between the measured change and the ideal 1LSB change between any two adjacent codes. The DNL error between any two codes is calculated as follows:

$$\text{DNL} = (\Delta V_{OUT} - \text{LSB})/\text{LSB}$$

ΔV_{OUT} = The measured voltage difference between two adjacent codes

Digital Feedthrough: The glitch that appears at the analog output caused by AC coupling from the digital inputs when they change state. The area of the glitch is specified in nV × sec.

